

FEATURES

Controlled Baseline

 One Assembly/Test Site, One Fabrication Site

- Enhanced Diminishing Manufacturing Sources (DMS) Support
- Enhanced Product-Change Notification
- Qualification Pedigree (1)
- Supports 5-V V_{cc} Operation
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 6.3 ns at 3.3 V
- Low Power Consumption, 10-μA Max I_{cc}
- ±24-mA Output Drive at 3.3 V
- I_{off} Supports Partial-Power-Down Mode Operation
- (1) Component qualification in accordance with JEDEC and industry standards to ensure reliable operation over an extended temperature range. This includes, but is not limited to, Highly Accelerated Stress Test (HAST) or biased 85/85, temperature cycle, autoclave or unbiased HAST, electromigration, bond intermetallic life, and mold compound life. Such qualification testing should not be viewed as justifying use of this component beyond specified performance and environmental limits.

DESCRIPTION/ORDERING INFORMATION

This configurable multiple-function gate is designed for 1.65-V to 5.5-V V_{CC} operation.

The SN74LVC1G98 features configurable multiple functions. The output state is determined by eight patterns of 3-bit input. The user can choose the logic functions MUX, AND, OR, NAND, NOR, inverter, and noninverter. All inputs can be connected to V_{CC} or GND.

This device functions as an independent gate, but because of Schmitt action, it may have different input threshold levels for positive-going (V_{T_+}) and negative-going (V_{T_-}) signals.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

ORDERING INFORMATION

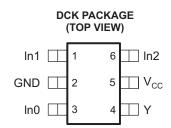
T _A	PACK	AGE ⁽¹⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING		
40%C to 95%C	SOT (SC-70) – DCK	Deal of 2000	SN74LVC1G98IDCKREP			
-40°C to 85°C	SUT (SC-70) - DCK	Reel of 3000	V62/013641-01XE	CWR		

(1) Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

- ESD Protection Exceeds JESD 22
- 2000-V Human-Body Model (A114-A)
- 200-V Machine Model (A115-A)
- 1000-V Charged-Device Model (C101)



See mechanical drawings for dimensions.

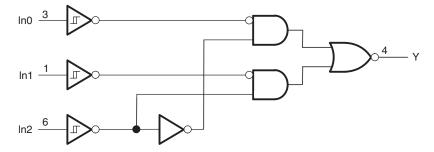
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FUNCTION TABLE

	INPUTS		OUTPUT
In2	ln1	In0	Y
L	L	L	Н
L	L	Н	Н
L	н	L	L
L	н	Н	L
н	L	L	Н
н	L	Н	L
н	н	L	Н
н	Н	н	L

LOGIC DIAGRAM (POSITIVE LOGIC)



FUNCTION SELECTION TABLE

LOGIC FUNCTION	FIGURE NO.
2-to-1 data selector with inverted output	1
2-input NAND gate	2
2-input NOR gate with one inverted input	3
2-input AND gate with one inverted input	3
2-input NAND gate with one inverted input	4
2-input OR gate with one inverted input	4
2-input NOR gate	5
Noninverted buffer	6
Inverter	7

Ц

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1

2

3

в

Figure 2. 2-Input NAND Gate

÷

GND

6

5

4

Α

Y

Vcc

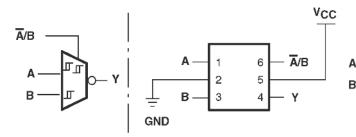
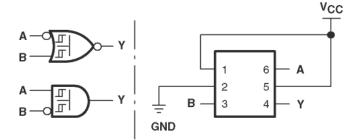


Figure 1. 2-to-1 Data Selector With Inverted Output



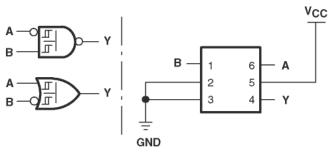


Figure 3. 2-Input NOR Gate With One Inverted Input 2-Input AND Gate With One Inverted Input

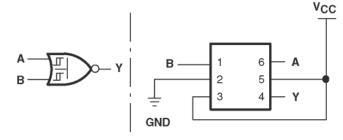


Figure 5. 2-Input NOR Gate

Figure 4. 2-Input NAND Gate With One Inverted Input 2-Input OR Gate With One Inverted Input

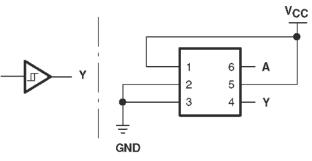


Figure 6. Noninverted Buffer

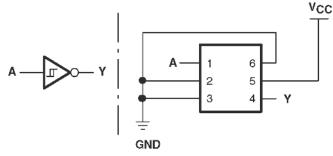


Figure 7. Inverter

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Absolute Maximum Ratings⁽¹⁾

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V_{CC}	Supply voltage range		-0.5	6.5	V
VI	Input voltage range ⁽²⁾	-0.5	6.5	V	
Vo	Voltage range applied to any output in the high	-0.5	6.5	V	
Vo	Voltage range applied to any output in the high or low state ⁽²⁾⁽³⁾			V _{CC} + 0.5	V
I _{IK}	Input clamp current	V ₁ < 0		-50	mA
I _{OK}	Output clamp current	V _O < 0		-50	mA
Ι _Ο	Continuous output current			±50	mA
	Continuous current through V_{CC} or GND			±100	mA
θ_{JA}	Package thermal impedance ⁽⁴⁾		259	°C/W	
T _{stg}	Storage temperature range		-65	150	°C

(1) Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.

(3) The value of V_{CC} is provided in the recommended operating conditions table.

(4) The package thermal impedance is calculated in accordance with JESD 51-7.

Recommended Operating Conditions⁽¹⁾

			MIN	MAX	UNIT	
V	Supply voltage	Operating		5.5	V	
V _{CC}	Supply voltage	Data retention only	1.5		v	
VI	Input voltage		0	5.5	V	
Vo	Output voltage		0	V_{CC}	V	
		V _{CC} = 1.65 V		-4		
	High-level output current	V _{CC} = 2.3 V		-8		
I _{OH}		<u> </u>		-16	mA	
		$V_{CC} = 3 V$		-24		
		$V_{CC} = 4.5 V$		-32		
		V _{CC} = 1.65 V		4		
		V _{CC} = 2.3 V		8		
I _{OL}	Low-level output current	<u>)/ - 2)/</u>		16	mA	
		$V_{CC} = 3 V$		24		
		$V_{CC} = 4.5 V$		32		
Τ _Α	Operating free-air temperature		-40	85	°C	

 All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

Electrical Characteristics⁽¹⁾

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V _{cc}	MIN	TYP ⁽¹⁾ MAX	UNIT			
		1.65 V	0.79	1.16				
V _{T+}		2.3 V	1.11	1.56				
Positive-going input threshold		3 V	1.5	1.87	V			
voltage		4.5 V	2.16	2.74				
		5.5 V	2.61	3.33				
		1.65 V	0.35	0.62				
V _{T-}		2.3 V	0.58	0.87				
Negative-going input threshold		3 V	0.84	1.19	V			
voltage		4.5 V	1.41	1.9				
		5.5 V	1.87	2.29				
		1.65 V	0.3	0.62				
ΔV_T		2.3 V	0.4	0.8				
Hysteresis		3 V	0.53	0.87	V			
$(V_{T+} - V_{T-})$		4.5 V	0.71	1.04				
		5.5 V	0.71	1.11				
	$I_{OH} = -100 \ \mu A$	1.65 V to 5.5 V	V _{CC} – 0.1					
	$I_{OH} = -4 \text{ mA}$	1.65 V	1.2					
M	$I_{OH} = -8 \text{ mA}$	2.3 V	1.9		v			
V _{OH}	$I_{OH} = -16 \text{ mA}$	- 3 V	2.4		v			
	$I_{OH} = -24 \text{ mA}$	- 3 V	2.3					
	$I_{OH} = -32 \text{ mA}$	4.5 V	3.8					
	I _{OL} = 100 μA	1.65 V to 5.5 V		0.1				
	I _{OL} = 4 mA	1.65 V		0.45				
N/	I _{OL} = 8 mA	2.3 V		0.3	v			
V _{OL}	I _{OL} = 16 mA	- 3 V		0.4	v			
	I _{OL} = 24 mA	- 3 V		0.55				
	I _{OL} = 32 mA	4.5 V	0.55					
I _I	$V_{I} = 5.5 \text{ V or GND}$	0 V to 5.5 V		±5	μA			
I _{off}	$V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	0 V		±10	μA			
I _{CC}	$V_{I} = 5.5 \text{ V or GND}, \qquad I_{O} = 0$	1.65 V to 5.5 V		10	μA			
ΔI_{CC}	One input at V_{CC} – 0.6 V, Other inputs at V_{CC} or GND	3 V to 5.5 V		500	μA			
C _i	$V_{I} = V_{CC}$ or GND	3.3 V		3.5	pF			

(1) All typical values are at V_{CC} = 3.3 V, $T_A = 25^{\circ}C$.

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Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 8)

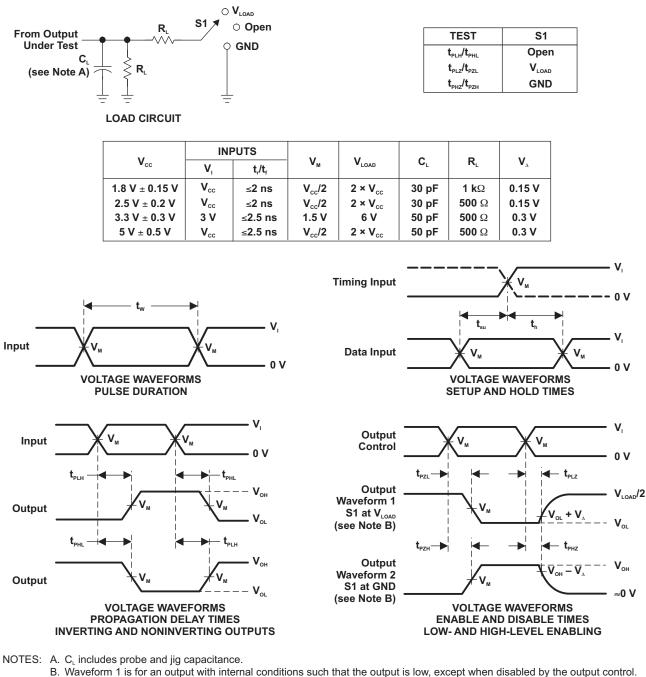
PARAMETER	FROM (INPUT)	TO (OUTPUT)	V _{CC} = 1.8 V ± 0.15 V		V_{CC} = 2.5 V \pm 0.2 V		V_{CC} = 3.3 V ± 0.3 V		V _{CC} = 5 V ± 0.5 V		UNIT
			MIN	MAX	MIN	MAX	MIN	MAX	MIN	MAX	
t _{pd}	Any In	Y	3.2	14.4	2	8.3	1.5	6.3	1.1	5.1	ns

Operating Characteristics

 $T_A = 25^{\circ}C$

PARAMETER		TEST	V _{CC} = 1.8 V	$V_{CC} = 2.5 V$	$V_{CC} = 3.3 V$	$V_{CC} = 5 V$	UNIT	
		CONDITIONS	TYP	TYP	TYP	TYP		
\mathbf{C}_{pd}	Power dissipation capacitance	f = 10 MHz	23	23	23	26	pF	

PARAMETER MEASUREMENT INFORMATION



 B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
C. All input pulses are supplied by generators having the following characteristics: PRR ≤ 10 MHz, Z₀ = 50 Ω.

- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHI} are the same as t_{ref} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 8. Load Circuit and Voltage Waveforms



10-Dec-2020

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
SN74LVC1G98IDCKREP	ACTIVE	SC70	DCK	6	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	CWR	Samples
V62/03641-01XE	ACTIVE	SC70	DCK	6	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	CWR	Samples

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <= 1000ppm threshold. Antimony trioxide based flame retardants must also meet the <= 1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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PACKAGE OPTION ADDENDUM

10-Dec-2020

OTHER QUALIFIED VERSIONS OF SN74LVC1G98-EP :

• Catalog: SN74LVC1G98

• Automotive: SN74LVC1G98-Q1

NOTE: Qualified Version Definitions:

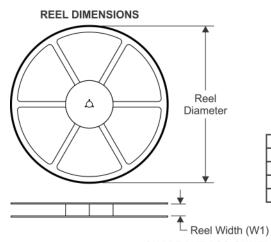
- Catalog TI's standard catalog product
- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects

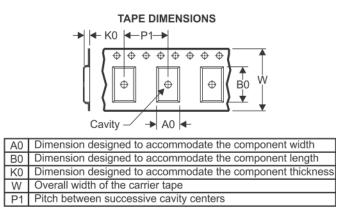
PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal												
Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LVC1G98IDCKREP	SC70	DCK	6	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3

TEXAS INSTRUMENTS

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PACKAGE MATERIALS INFORMATION

25-Sep-2019

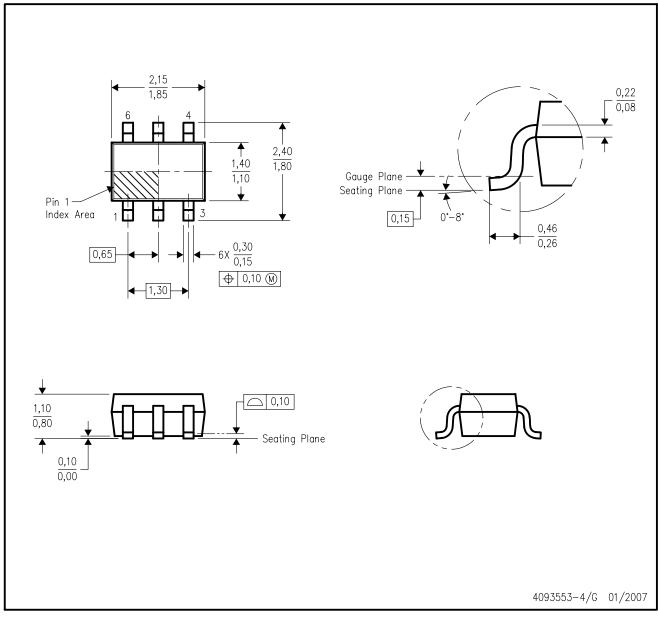


*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LVC1G98IDCKREP	SC70	DCK	6	3000	202.0	201.0	28.0

DCK (R-PDSO-G6)

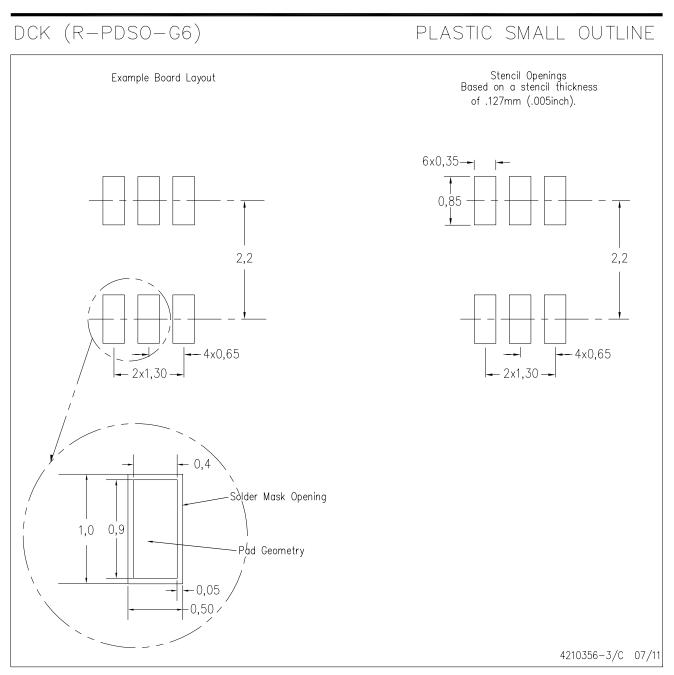
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES: A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
 - D. Falls within JEDEC MO-203 variation AB.



LAND PATTERN DATA



NOTES:

- A. All linear dimensions are in millimeters.B. This drawing is subject to change without notice.
- C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
- D. Publication IPC-7351 is recommended for alternate designs.
- E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.



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